

# SN75ALS162

## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVER

SLLS020C – JUNE 1986 – REVISED MAY 1995

- Meets IEEE Standard 488-1978 (GPIB)
- 8-Channel Bidirectional Transceiver
- Designed to Implement Control Bus Interface
- Designed for Multicontrollers
- High-Speed Advanced Low-Power Schottky Circuitry
- Low-Power Dissipation . . . 46 mW Max per Channel
- Fast Propagation Times . . . 20 ns Max
- High-Impedance PNP Inputs
- Receiver Hysteresis . . . 650 mV Typ
- Bus-Terminating Resistors Provided on Driver Outputs
- No Loading of Bus When Device Is Powered Down ( $V_{CC} = 0$ )
- Power-Up/Power-Down Protection (Glitch Free)

### description

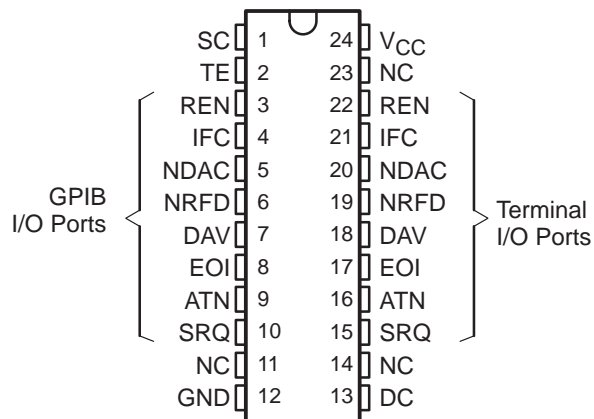
The SN75ALS162 eight-channel general-purpose interface bus (GPIB) transceiver is a monolithic, high-speed, advanced low-power Schottky process device designed to provide the bus-management and data-transfer signals between operating units of a multiple-controller instrumentation system. When combined with the SN75ALS160 octal bus transceiver, the SN75ALS162 provides the complete 16-wire interface for the IEEE 488 bus.

The SN75ALS162 features eight driver-receiver pairs connected in a front-to-back configuration to form input/output (I/O) ports at both the bus and terminal sides. The direction of data through these driver-receiver pairs is determined by the DC, TE, and SC enable signals. The SC input allows the REN and IFC transceivers to be controlled independently.

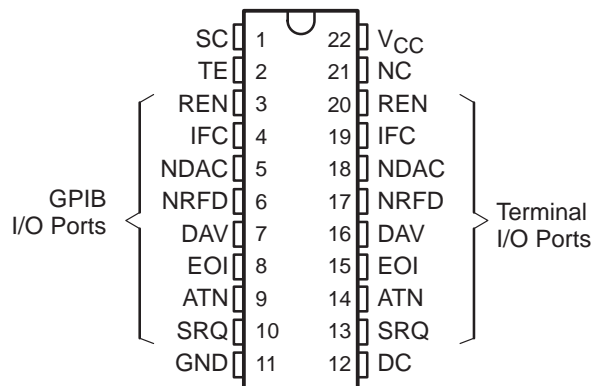
The driver outputs (GPIB I/O ports) feature active bus-terminating resistor circuits designed to provide a high impedance to the bus when  $V_{CC} = 0$ . The drivers are designed to handle loads up to 48 mA of sink current. Each receiver features pnp transistor inputs for high input impedance and hysteresis of 400 mV minimum for increased noise immunity. All receivers have 3-state outputs to present a high impedance to the terminal when disabled.

The SN75ALS162 is characterized for operation from 0°C to 70°C.

**DW PACKAGE**  
(TOP VIEW)



**N PACKAGE**  
(TOP VIEW)



NC—No internal connection



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# SN75ALS162 OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVER

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RECEIVE/TRANSMIT FUNCTION TABLE

CONTROLS				BUS-MANAGEMENT CHANNELS				DATA-TRANSFER CHANNELS				
SC	DC	TE	ATN†	ATN† (controlled by DC)	SRQ	REN (controlled by SC)	IFC	EOI	DAV	NDAC	NRFD (controlled by TE)	
	H	H	H	R	T			T	T	R	R	
	H	H	L					R				
	L	L	H	T	R			R	R	T	T	T
	L	L	L					T				
	H	L	X	R	T			R	R	T	T	
	L	H	X	T	R			T	T	R	R	
H						T	T					
L						R	R					

H = high level, L = low level, R = receive, T = transmit, X = irrelevant

Direction of data transmission is from the terminal side to the bus side, and the direction of data receiving is from the bus side to the terminal side.

Data transfer is noninverting in both directions.

† ATN is a normal transceiver channel that functions additionally as an internal direction control or talk enable for EOI whenever the DC and TE inputs are in the same state. When DC and TE are in opposite states, the ATN channel functions as an independent transceiver only.

CHANNEL IDENTIFICATION TABLE

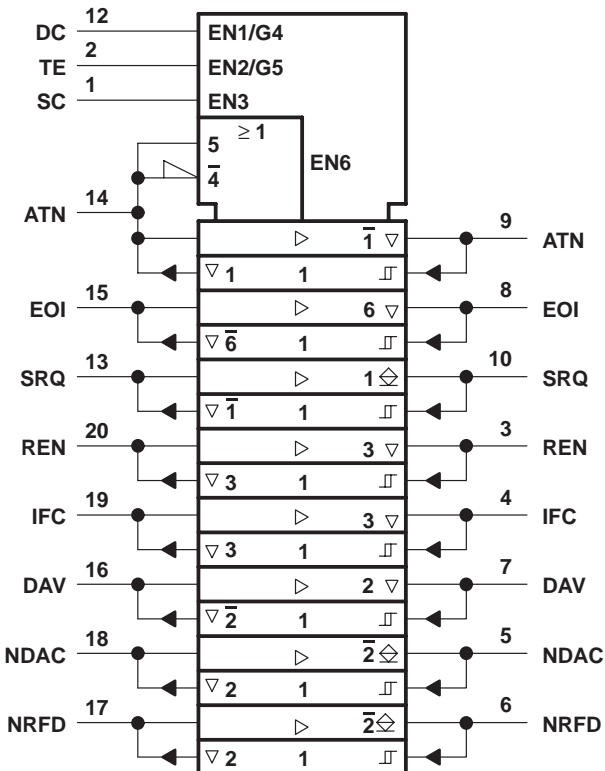
NAME	IDENTITY	CLASS
DC	Direction Control	Control
TE	Talk Enable	
SC	System Control	
ATN	Attention	Bus Management
SRQ	Service Request	
REN	Remote Enable	
IFC	Interface Clear	
EOI	End or Identify	
DAV	Data Valid	Data Transfer
NDAC	No Data Accepted	
NRFD	Not Ready for Data	



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logic symbol†



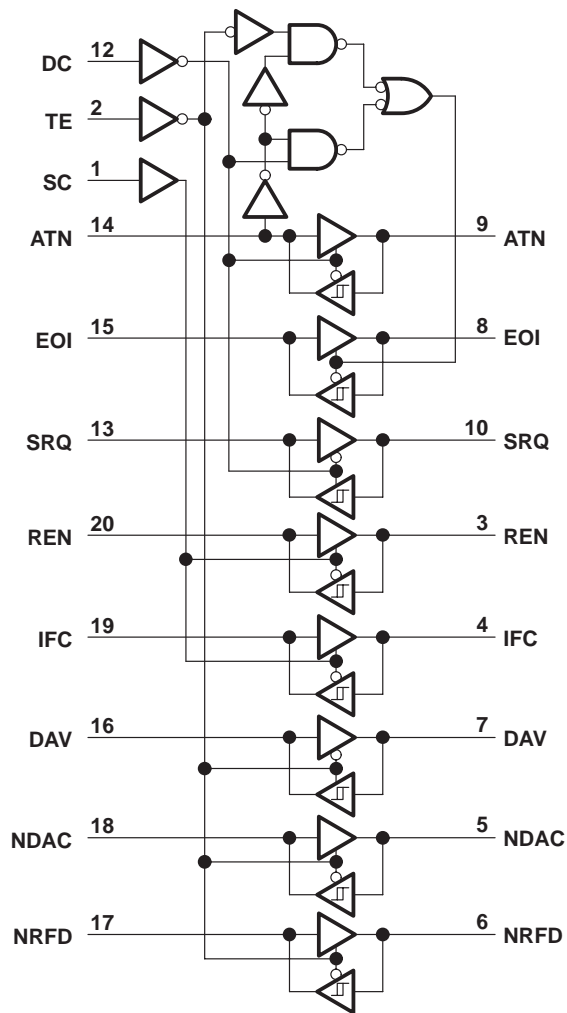
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

▽ Designates 3-state outputs

◇ Designates passive-pullup outputs

Pin numbers shown are for the N package.

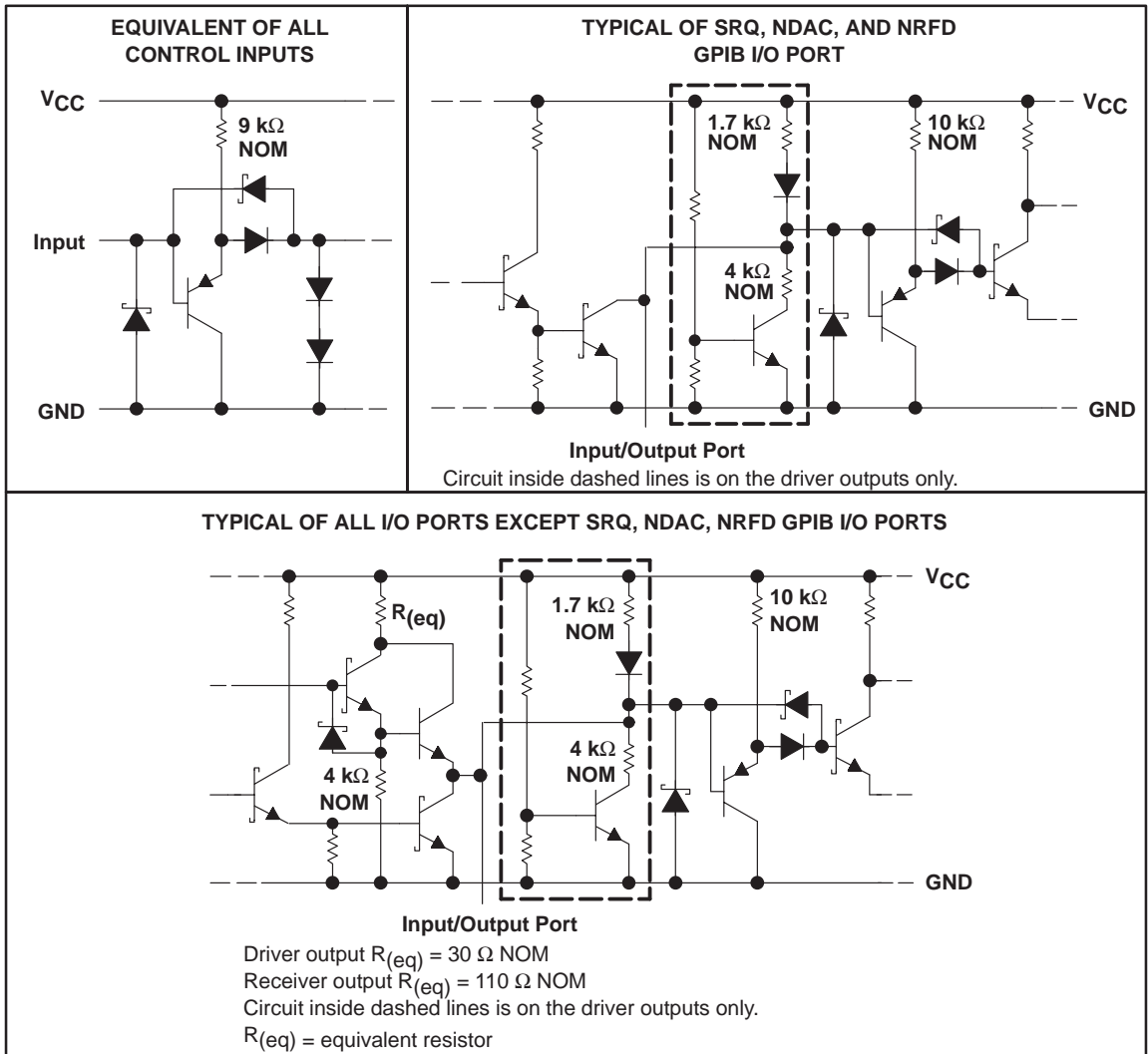
logic diagram (positive logic)



# SN75ALS162 OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVER

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## schematics of inputs and outputs



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage, $V_I$	5.5 V
Low-level driver output current, $I_{OL}$	100 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$	0°C to 70°C
Storage temperature range, $T_{stg}$	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from the case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to network ground terminal.

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## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVER

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**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR	$T_A = 70^\circ\text{C}$ POWER RATING
DW	1350 mW	10.8 mW/°C	864 mW
N	1700 mW	13.6 mW/°C	1088 mW

### recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$		4.75	5	5.25	V
High-level input voltage, $V_{IH}$		2			V
Low level input voltage, $V_{IL}$				0.8	V
High-level output current, $I_{OH}$	Bus ports with 3-state outputs			-5.2	mA
	Terminal ports			-800	$\mu\text{A}$
Low-level output current, $I_{OL}$	Bus ports			48	mA
	Terminal ports			16	
Operating free-air temperature, $T_A$		0		70	°C

### electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
$V_{IK}$	Input clamp voltage	$I_I = -18 \text{ mA}$		-0.8	-1.5		V	
$V_{hys}$	Hysteresis voltage ( $V_{IT+} - V_{IT-}$ )	Bus		0.4	0.65		V	
$V_{OH}^\ddagger$	High-level output voltage	Terminal	$I_{OH} = -800 \mu\text{A}$	2.7	3.5		V	
		Bus	$I_{OH} = -5.2 \text{ mA}$	2.5	3.3			
$V_{OL}$	Low-level output voltage	Terminal	$I_{OL} = 16 \text{ mA}$		0.3	0.5	V	
		Bus	$I_{OL} = 48 \text{ mA}$		0.35	0.5		
$I_I$	Input current at maximum input voltage	Terminal		$V_I = 5.5 \text{ V}$		0.2	100	$\mu\text{A}$
$I_{IH}$	High-level input current	Terminal and control inputs		$V_I = 2.7 \text{ V}$		0.1	20	$\mu\text{A}$
$I_{IL}$	Low-level input current	Terminal and control inputs		$V_I = 0.5 \text{ V}$		-10	-100	$\mu\text{A}$
$V_{I/O(\text{bus})}$	Voltage at bus port	Driver disabled	$I_{I(\text{bus})} = 0$	2.5	3.0	3.7	V	
			$I_{I(\text{bus})} = -12 \text{ mA}$			-1.5		
$I_{I/O(\text{bus})}$	Current into bus port	Power on	Driver disabled	$V_{I(\text{bus})} = -1.5 \text{ V to } 0.4 \text{ V}$	-1.3		mA	
				$V_{I(\text{bus})} = 0.4 \text{ V to } 2.5 \text{ V}$	0	-3.2		
				$V_{I(\text{bus})} = 2.5 \text{ V to } 3.7 \text{ V}$		+2.5 -3.2		
				$V_{I(\text{bus})} = 3.7 \text{ V to } 5 \text{ V}$	0	2.5		
				$V_{I(\text{bus})} = 5 \text{ V to } 5.5 \text{ V}$	0.7	2.5		
	Power off	$V_{CC} = 0, V_{I(\text{bus})} = 0 \text{ to } 2.5 \text{ V}$				-40	$\mu\text{A}$	
$I_{OS}$	Short-circuit output current	Terminal		-15	-35	-75	mA	
		Bus		-25	-50	-125		
$I_{CC}$	Supply current	No load, TE, DC, and SC low			55	75	mA	
$C_{I/O(\text{bus})}$	Bus-port capacitance	$V_{CC} = 0 \text{ to } 5 \text{ V}, V_{I/O} = 0 \text{ to } 2 \text{ V}, f = 1 \text{ MHz}$			30		pF	

† All typical values are at  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ .

‡  $V_{OH}$  applies to 3-state outputs only.



# SN75ALS162

## OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVER

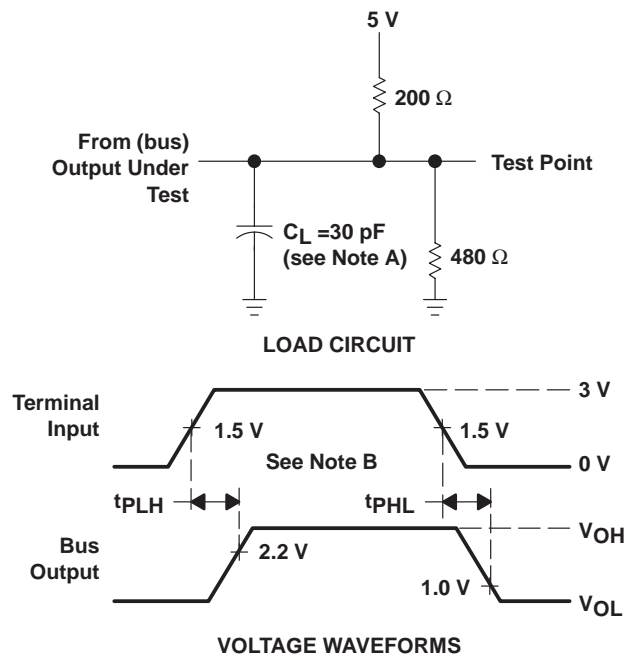
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switching characteristics over recommended range of operating free-air temperature,  $V_{CC} = 5\text{ V}$

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
$t_{PLH}$	Propagation delay time, low- to high-level output	Terminal	Bus	$C_L = 30\text{ pF}$ , See Figure 1	10	20	ns	
$t_{PHL}$	Propagation delay time, high- to low-level output				12	20		
$t_{PLH}$	Propagation delay time, low- to high-level output	Bus	Terminal	$C_L = 30\text{ pF}$ , See Figure 2	5	10	ns	
$t_{PHL}$	Propagation delay time, high- to low-level output				7	14		
$t_{PZH}$	Output enable time to high level	TE, DC, or SC	Bus (ATN, EOI, REN, IFC, and DAV)	$C_L = 15\text{ pF}$ , See Figure 3			30	ns
$t_{PHZ}$	Output disable time from high level						20	
$t_{PZL}$	Output enable time to low level						45	
$t_{PLZ}$	Output disable time from low level						20	
$t_{PZH}$	Output enable time to high level	TE, DC, or SC	Terminal	$C_L = 15\text{ pF}$ , See Figure 4			30	ns
$t_{PHZ}$	Output disable time from high level						25	
$t_{PZL}$	Output enable time to low level						30	
$t_{PLZ}$	Output disable time from low level						25	

† All typical values are at  $T_A = 25^\circ\text{C}$ .

### PARAMETER MEASUREMENT INFORMATION

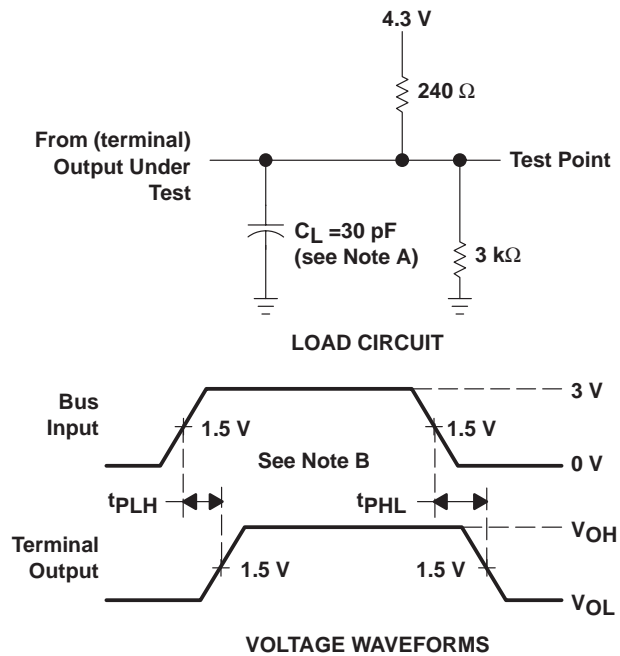


NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq 1\text{ MHz}$ , 50% duty cycle,  $t_r \leq 6\text{ ns}$ ,  $t_f \leq 6\text{ ns}$ ,  $Z_O = 50\ \Omega$ .

Figure 1. Terminal-to-Bus Load Circuit and Voltage Waveforms

**PARAMETER MEASUREMENT INFORMATION**



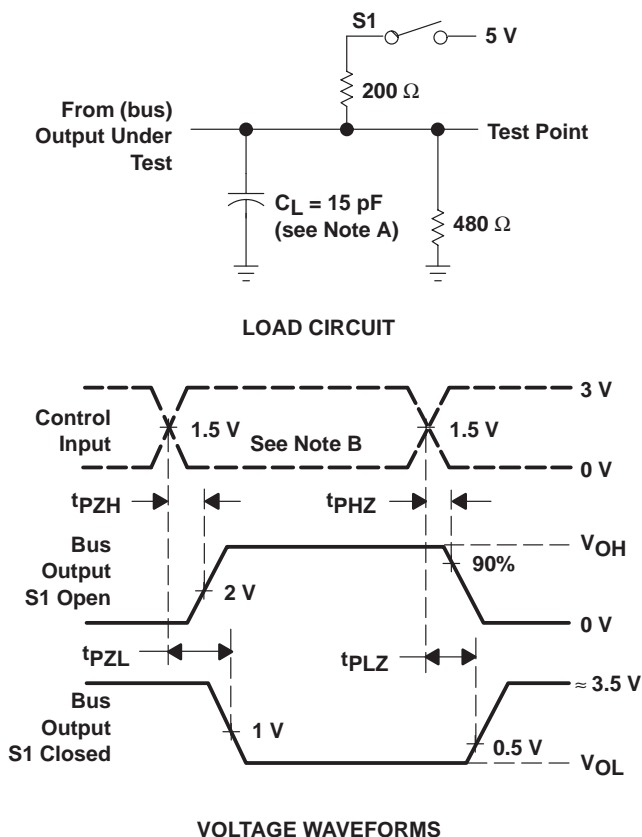
- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The input pulse is supplied by a generator having the following characteristics:  $PRR \leq 1 \text{ MHz}$ , 50% duty cycle,  $t_r \leq 6 \text{ ns}$ ,  $t_f \leq 6 \text{ ns}$ ,  $Z_O = 50 \Omega$ .

**Figure 2. Bus-to-Terminal Load Circuit and Voltage Waveforms**

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## PARAMETER MEASUREMENT INFORMATION

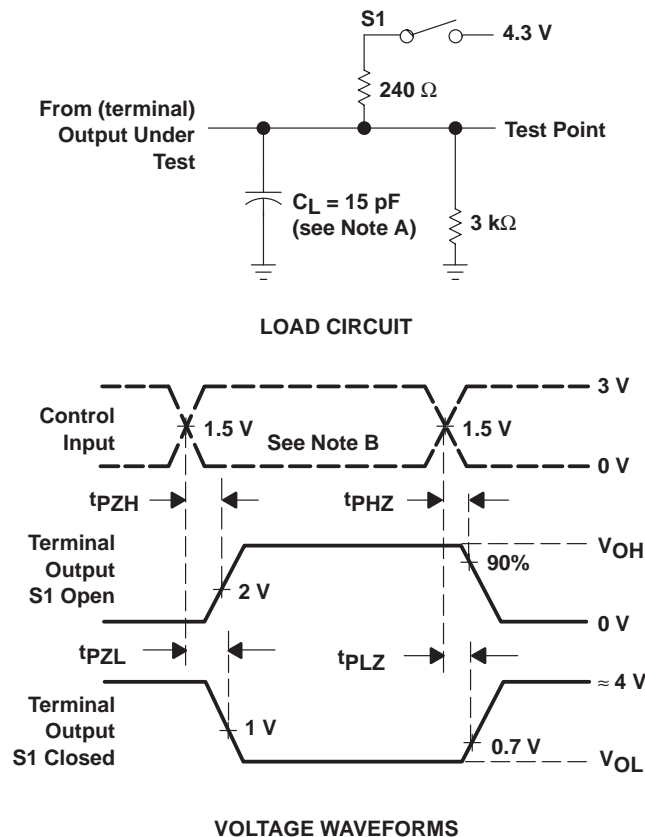


- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The input pulse is supplied by a generator having the following characteristics:  $PRR \leq 1$  MHz, 50% duty cycle,  $t_r \leq 6$  ns,  $t_f \leq 6$  ns,  $Z_O = 50 \Omega$ .

**Figure 3. Bus Load Circuit and Voltage Waveforms**



**PARAMETER MEASUREMENT INFORMATION**



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The input pulse is supplied by a generator having the following characteristics:  $PRR \leq 1$  MHz, 50% duty cycle,  $t_r \leq 6$  ns,  $t_f \leq 6$  ns,  $Z_O = 50 \Omega$ .

**Figure 4. Terminal Load Circuit and Voltage Waveforms**

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## TYPICAL CHARACTERISTICS

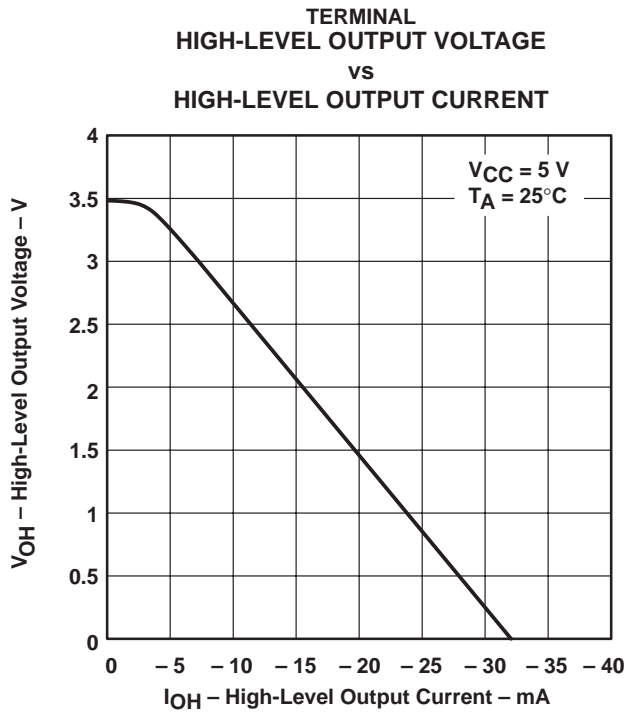


Figure 5

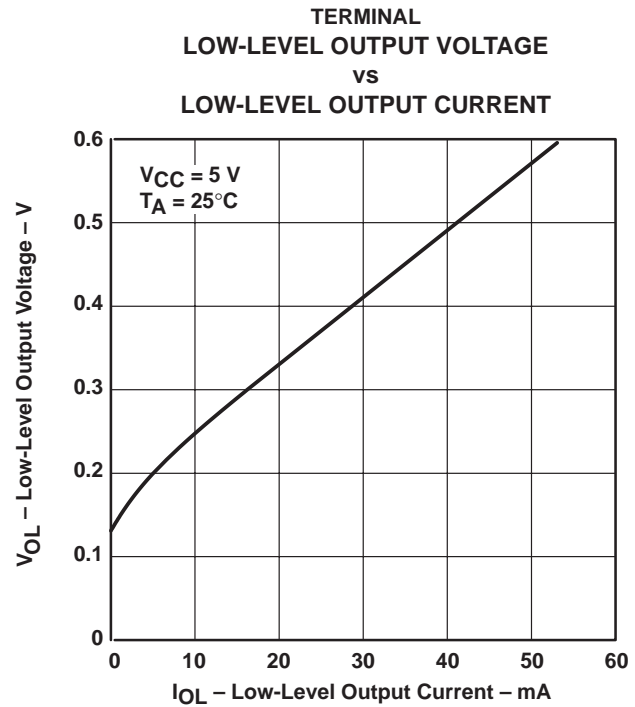


Figure 6

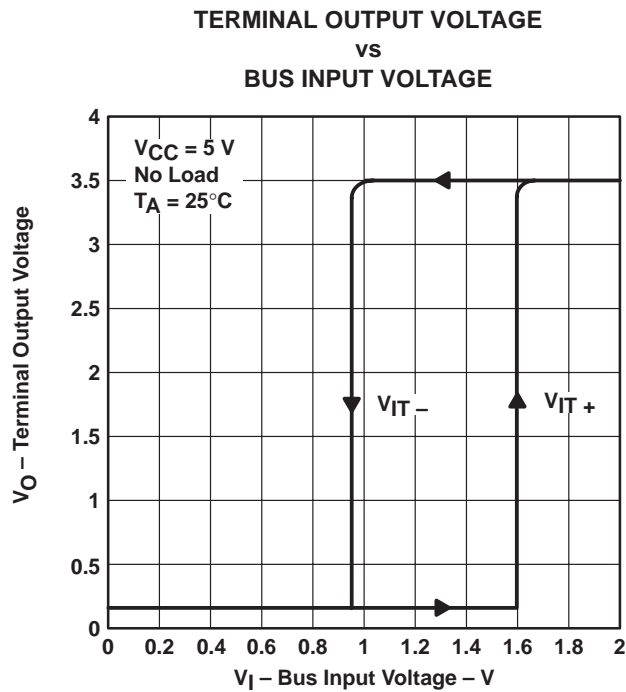


Figure 7

TYPICAL CHARACTERISTICS

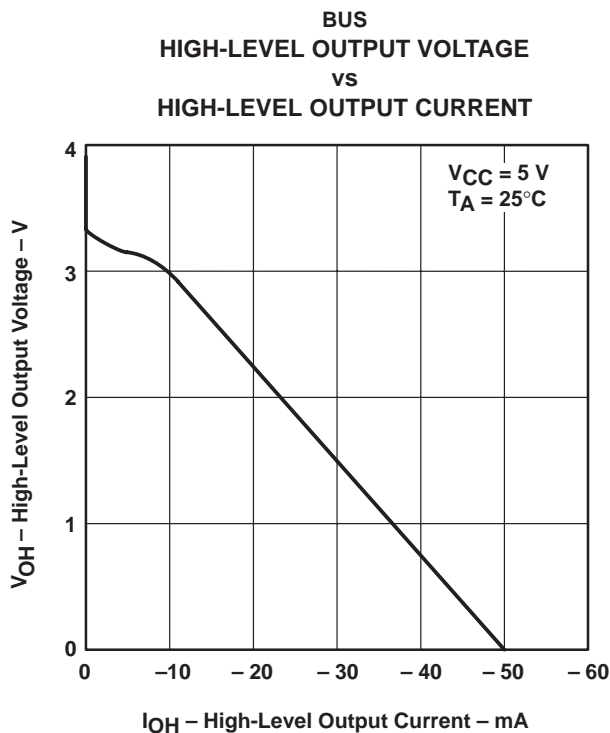


Figure 8

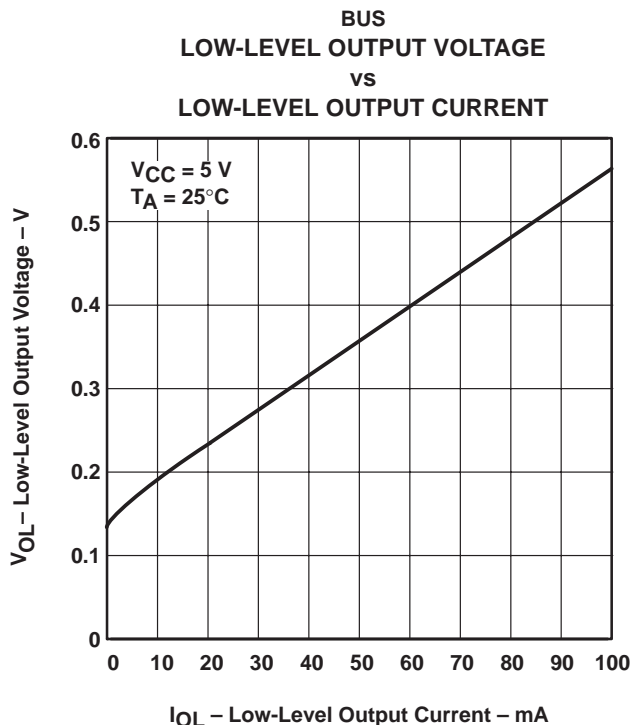


Figure 9

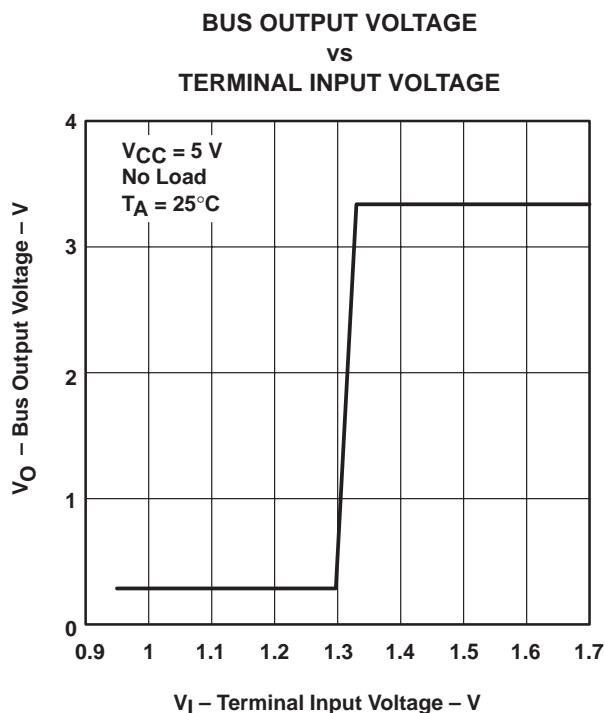


Figure 10

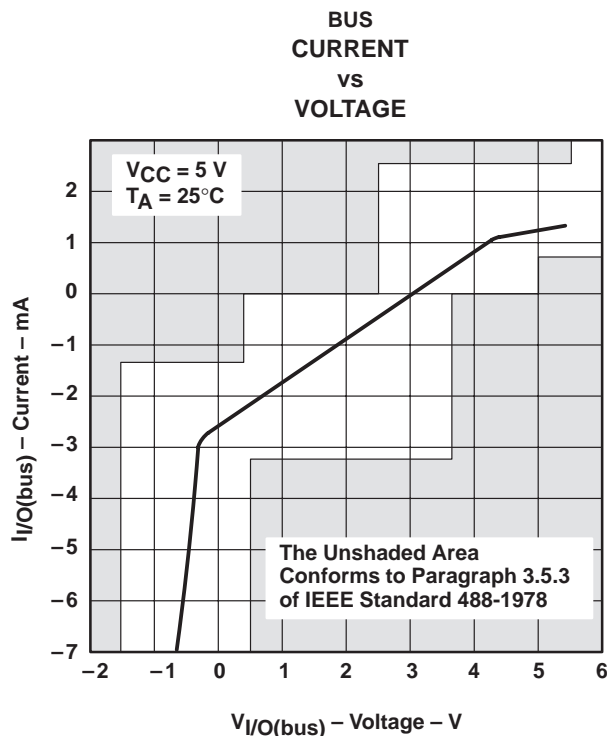


Figure 11

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN75ALS162DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162DWRG4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS162N	OBSOLETE	PDIP	N	22		TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS162DWR	SOIC	DW	24	2000	330.0	24.4	10.85	15.8	2.7	12.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS162DWR	SOIC	DW	24	2000	346.0	346.0	41.0



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Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>

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Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
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Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
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